Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Diodes Incorporated</u> <u>ZXTPS717MCTA</u>

For any questions, you can email us directly: sales@integrated-circuit.com



Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





A Product Line of Diodes Incorporated

ZXTPS717MC

12V PNP LOW SATURATION TRANSISTOR AND 40V, 1A SCHOTTKY DIODE COMBINATION

Features and Benefits

PNP Transistor

- BV_{CEO} > -12V
- I_C = -4A Continuous Collector Current
- Low Saturation Voltage (-140mV max @ -1A)
- $R_{SAT} = 65m\Omega$ for a low equivalent On-Resistance
- hFE characterized up to -10A for high current gain hold up

Schottky Diode

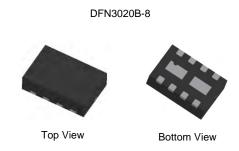
- BV_R > 40V
- I_{FAV} = 3A Average Peak Forward Current
- Low V_F < 500mV (@1A) for reduced power loss
- Fast switching due to Schottky barrier
- Low profile 0.8mm high package for thin applications
- R_{θJA} efficient, 40% lower than SOT26
- 6mm² footprint, 50% smaller than TSOP6 and SOT26
- Lead-Free, RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

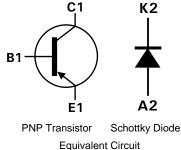
Mechanical Data

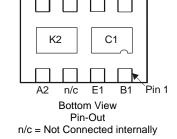
- Case: DFN3020B-8
- Case Material: Molded Plastic, "Green" Molding Component
- Terminals: Pre-Plated NiPdAu leadframe
- Nominal package height: 0.8mm
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.013 grams (approximate)

Applications

- DC DC Converters
- Charging circuits
- Mobile phones
- Motor control
- Portable applications







Ordering Information (Note 3)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTPS717MCTA	1S1	7	8	3000

Notes:

- 1. No purposefully added lead.
- Diodes Inc's "Green" Policy can be found on our website http://www.diodes.com
- 3. For packaging details, go to our website http://www.diodes.com

Marking Information

1S1 •

1S1 = Product type marking code Top view, dot denotes pin 1



Distributor of Diodes Incorporated: Excellent Integrated System Limited Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





ZXTPS717MC

PNP - Maximum Ratings @ TA = 25°C unless otherwise specified

Parameter		Symbol	Limit	Unit
Collector-Base Voltage		V_{CBO}	-20	
Collector-Emitter Voltage		V_{CEO}	-12	V
Emitter-Base Voltage		V_{EBO}	-7	
Peak Pulse Current		I _{CM}	-12	
Continuous Collector Current (Notes 4 and 7) (Notes 5 and 7)		l _a	-4	
		lc [-4.4	^
Base Current		Ι _Β	-1	

PNP - Thermal Characteristics @ TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
	(Notes 4 & 7)		1.5 12		
Power Dissipation	(Notes 5 & 7)		2.45 19.6	W mW/°C	
Linear Derating Factor	(Notes 6 & 7)	P _D	1.13 8		
	(Notes 6 & 8)		1.7 13.6		
	(Notes 4 & 7)		83.3		
The arrest Desistance I have the a technique	(Notes 5 & 7)	_	51.0	°C/W	
Thermal Resistance, Junction to Ambient	(Notes 6 & 7)	$R_{\theta JA}$	111		
	(Notes 6 & 8)		73.5		
Thermal Resistance, Junction to Lead	(Note 9)	$R_{ heta JL}$	17.1		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Notes:

- 4. For a dual device surface mounted on 28mm x 28mm (8cm²) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed collector and cathode pads connected to each half.
- 5. Same as note (4), except the device is measured at t <5 sec.
- 6. Same as note (4), except the device is surface mounted on 31mm x 31mm (10cm²) FR4 PCB with high coverage of single sided 1oz copper. 7. For a dual device with one active die.
- 8. For dual device with 2 active die running at equal power.
- 9. Thermal resistance from junction to solder-point (on the exposed collector pad).

Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

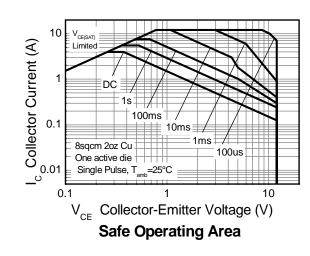
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

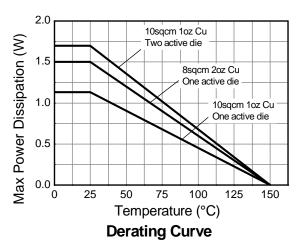




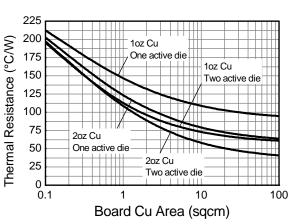
ZXTPS717MC

PNP - Thermal Characteristics



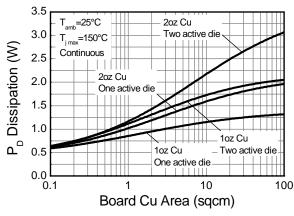


8sqcm 2oz Cu Thermal Resistance (°C/W) One active die 60 D=0.5 40 Single Pulse D=0.2D=0.05 D=0.1 100m 10 100 100µ 1k Pulse Width (s)



Transient Thermal Impedance

Thermal Resistance v Board Area



Power Dissipation v Board Area



Distributor of Diodes Incorporated: Excellent Integrated System Limited Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





ZXTPS717MC

Schottky - Maximum Ratings @ TA = 25°C unless otherwise specified

Parameter	Symbol	Limit	Unit	
Continuous Reverse Voltage		V_R	40	V
Continuous Forward Current		I _F	1.85	
Repetitive Peak Forward Current D = 0.5 Pulse width ≤ 300µs		I _{FRM}	3	A
Non Bonotitivo Book Forward Surgo Current	t ≤ 100µs	1	12	1
Non-Repetitive Peak Forward Surge Current	t ≤ 10ms	IFSM	7	

Schottky - Thermal Characteristics @ TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
	(Notes 10 & 13)		1.2 12		
Power Dissipation	(Notes 11 & 13)		2 20	W	
Linear Derating Factor	(Notes 12 & 13)	P _D	0.9 9	mW/°C	
	(Notes 12 & 14)		1.36 13.6		
	(Notes 10 & 13)		83.3	°C/W	
Thormal Posistance Junation to Ambient	(Notes 11 & 13)	_	51.0		
Thermal Resistance, Junction to Ambient	(Notes 12 & 13)	$R_{\theta JA}$	111		
	(Notes 12 & 14)		73.5		
Thermal Resistance, Junction to Lead	(Note 15)	$R_{ heta JL}$	20.2		
Storage Temperature Range		T _{STG}	-55 to +150	00	
Maximum Junction Temperature		TJ	125	°C	

- 10. For a dual device surface mounted on 28mm x 28mm (8cm²) FR4 PCB with high coverage of single sided 2 oz copper, in still air conditions; the device is measured when operating in a steady-state condition. The heatsink is split in half with the exposed cathode and collector pads connected to each half.
- 11. Same as note (10), except the device is measured at t <5 sec.
- 12. Same as note (10), except the device is surface mounted on 31mm x 31mm (10cm²) FR4 PCB with high coverage of single sided 1oz copper.

 13. For a dual device with one active die.
- 14. For dual device with 2 active die running at equal power.
- 15. Thermal resistance from junction to solder-point (on the exposed cathode pad).

225

0

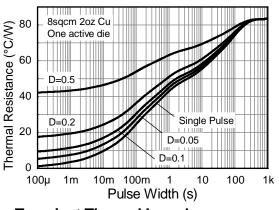
0.1

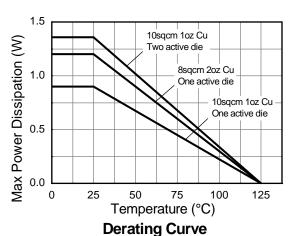




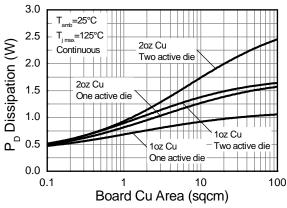
ZXTPS717MC

Schottky - Thermal Characteristics





Transient Thermal Impedance



200 Thermal Resistance (°C/W) 1oz Cu 175 One active die 150 Two active die 125 100 75 2oz Cu 50 One active die 2oz Cu 25 Two active die

Power Dissipation v Board Area

Thermal Resistance v Board Area

Board Cu Area (sqcm)

100



Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





ZXTPS717MC

PNP - Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-20	-35	-	V	$I_{C} = -100 \mu A$
Collector-Emitter Breakdown Voltage (Note 16)	BV _{CEO}	-12	-25	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.5	-	V	I _E = -100μA
Collector Cutoff Current	I _{CBO}	-	-	-100	nA	V _{CB} = -16V
Emitter Cutoff Current	I _{EBO}	-	-	-100	nA	V _{EB} = -6V
Collector Emitter Cutoff Current	I _{CES}	-	-	-100	nA	V _{CES} = -10V
		300	475	-		$I_C = -10 \text{mA}, V_{CE} = -2 \text{V}$
		300	450	-		$I_C = -100 \text{mA}, V_{CE} = -2 \text{V}$
Static Forward Current Transfer Ratio (Note 16)	h _{FE}	180	275	-	-	I _C = -2.5A, V _{CE} = -2V
		60	100	-		I _C = -8A, V _{CE} = -2V
		45	70	-		I _C = -10A, V _{CE} = -2V
		-	-10	-17		$I_C = -0.1A$, $I_B = -10mA$
		-	-100	-140		$I_C = -1A$, $I_B = -10mA$
Collector-Emitter Saturation Voltage (Note 16)	$V_{CE(sat)}$	-	-100	-150	mV	$I_C = -1.5A$, $I_B = -50mA$
	, ,	-	-195	-300		$I_C = -3A$, $I_B = -50mA$
		-	-240	-310		$I_C = -4A$, $I_B = -150mA$
Base-Emitter Turn-On Voltage (Note 16)	V _{BE(on)}	-	-0.87	-0.96	V	$I_C = -4A$, $V_{CE} = -2V$
Base-Emitter Saturation Voltage (Note 16)	V _{BE(sat)}	-	-0.97	-1.07	V	I _C = -4A, I _B = -150mA
Output Capacitance	C _{obo}	-	21	30	pF	V _{CB} = -10V, f = 1MHz
Transition Frequency	f _T	100	110	-	MHz	$V_{CE} = -10V, I_{C} = -50mA,$ f = 100MHz
Turn-on Time	t _{on}	-	70	-	Ns	$V_{CC} = -6V, I_{C} = -2A$
Turn-off Time	t _{off}	-	130	-	Ns	$I_{B1} = I_{B2} = -50 \text{mA}$

Schottky - Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	BV _R	40	60	-	V	I _R = -300μA
		-	240	270		I _F = 50mA
		-	265	290	mV	I _F = 100mA
		-	305	340		I _F = 250mA
Forward Voltage (Note 16)	V	-	355	400		I _F = 500mA
Polward Voltage (Note 16)	V_{F}	-	390	450		I _F = 750mA
		-	425	500		I _F = 1000mA
		-	495	600		I _F = 1500mA
		-	420	-		I _F = 1000mA, T _A = 100°C
Reverse Current	I _R	-	50	100	μΑ	V _R = 30V
Diode Capacitance	C _D	-	25	-	pF	V _R = 25V, f = 1MHz
	t _{rr}					switched from
Reverse Recovery Time		-	12	12 -	ns	$I_F = 500 \text{mA}$ to $I_R = 500 \text{mA}$
						Measured at I _R = 50mA

Notes: 16. Measured under pulsed conditions. Pulse width \leq 300 μ s. Duty cycle \leq 2%.

Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

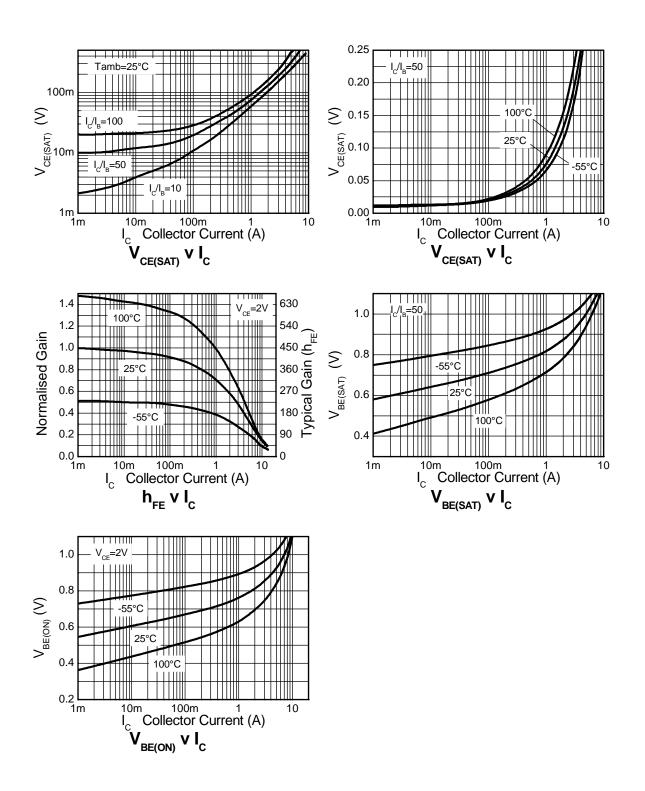
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





ZXTPS717MC

PNP - Typical Electrical Characteristics



Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

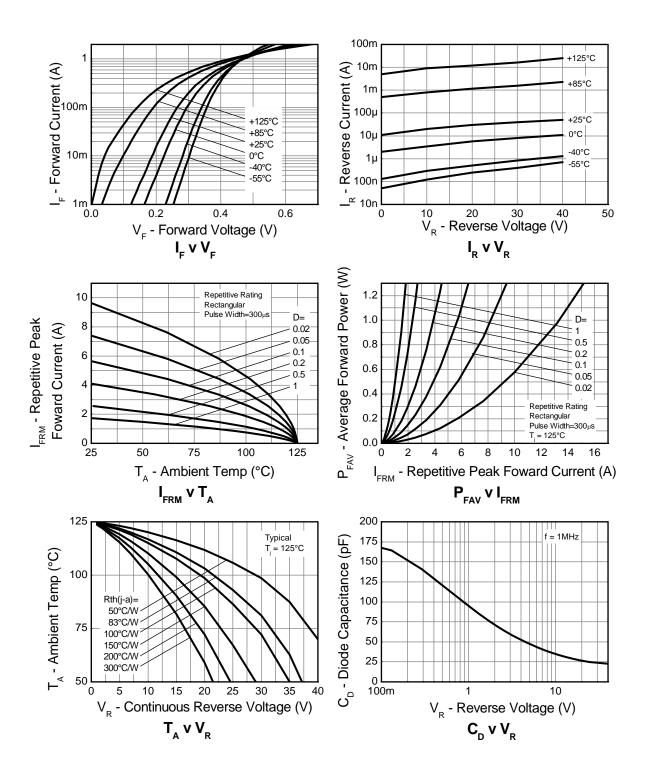
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





ZXTPS717MC

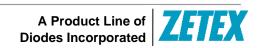
Schottky - Typical Electrical Characteristics



Datasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

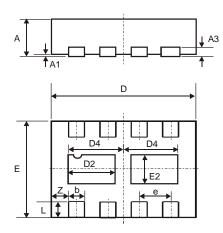
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





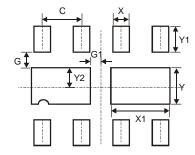
ZXTPS717MC

Package Outline Dimensions



DFN3020B-8					
Dim	Min	Max	Тур		
Α	0.77	0.83	0.80		
A1	0	0.05	0.02		
A3		-	0.15		
b	0.25	0.35	0.30		
D	2.95	3.075	3.00		
D2	0.82	1.02	0.92		
D4	1.01	1.21	1.11		
е	-	-	0.65		
Е	1.95	2.075	2.00		
E2	0.43	0.63	0.53		
L	0.25	0.35	0.30		
Z	-	-	0.375		
All Dimensions in mm					

Suggested Pad Layout



Dimensions	Value (in mm)
С	0.650
G	0.285
G1	0.090
Х	0.400
X1	1.120
Υ	0.730
Y1	0.500
Y2	0.365



Distributor of Diodes Incorporated: Excellent Integrated System LimitedDatasheet of ZXTPS717MCTA - TRANS PNP 12V 4A DFN

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





ZXTPS717MC

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- C. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- D. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices-or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2011, Diodes Incorporated

www.diodes.com